# PARALLELOGRAM

# **Read Head Assembly** For Magnetic Stripes



# Reads Magnetic Stripes

The Parallelogram Head Assembly from ID TECH features a distinct design ideal for any application that requires magnetic stripe reading. Available in either single, dual or triple track configurations, the head assembly accurately reads media conforming to ISO 7811 standards.

#### Unique Design

ID TECH's head assembly uses Parallelogram design to ensure the head maintains excellent contact with the card at a proper force. As a card passes by the head, the Parallelogram design maintains the head gap location to the card surface for any thickness of card. By preventing gap rotation, the head gap sustains strong contact with the magnetic stripe to assure the data is read accurately. The spring design provides gimbaling to insure consistent head to stripe contact on warped or bent cards.

## **Reliable Performance**

Guaranteed to read at least 1,000,000 cycles, the head assembly is a superior and dependable solution for decoding magnetic information. The waterproof head features embedded and strain relieved wires, making the head assembly an excellent choice for products used outdoors or in harsh & wet conditions.

# Simple and Versatile

The head assembly design eases the implementation process through the use of a single mounting point. It's small profile and footprint conserves space and allows it to fit into many applications. Because of its unique cantilevered design, the parallelogram head assembly can be integrated into applications that require mounting the magnetic head near the envelope of the unit.

#### Features:

- Head Life: 1,000,000 cycles minimum
- Single, Dual or Triple track options
- Exceptional read performance through its unique parallelogram design
- Small footprint and single mounting hole allow easy implementation
- Magnetic head can be mounted near the envelope of a unit
- Excellent gimballing capabilities
- Reads cards that meet industry standards
- Waterproof & strain relieved wires
- Cantilevered head design with single mounting hole
- Operates bi-directionally



# ID-80081202-XXX Parallelogram Head Assembly Specifications

#### Electrical

Data Densities: DC Resistance: Inductance: Insulation: Output Voltage: Head Ground: 2 to 22 bits/mm (50 to 550 bpi). 280 ±20% Ohms. 110 ±20% MH. 50 megOhms @250VDC. 35mV P-P @210bpi & 7.5ips typical. 10 Ohms maximum wire to case.

# Environmental

Operating Temperature: Storage Temperature: Humidity: Moisture: -40 °C to 75 °C (-40 ° F to 167 ° F). -50 °C to 95 °C (-58 ° F to 203 ° F). 10% to 99% relative. Embedded wires, no exposed connections.

Reliability

Head Life: Spring Life: 1,000,000 card passes, benign environment. 1,000,000 operations within travel limits.

## Mechanical

Track ETW: Gap Length: Wire Length: ISO Specification: Head Pre-load: Spring Deflection: Swipe Direction: Footprint:  $\begin{array}{l} 1.5 mm \pm 0.1 \; (0.06 \pm 0.004 \; in). \\ 0.0125 mm \; (0.0005 in). \\ 145 mm \pm 5 mm \; (5.6 \pm 0.2 \; in). \\ \text{Meets ISO 7811 specification for track location(s).} \\ 0.4 mm \pm 0.125 mm \; (0.016 \pm 0.05 \; in). \\ 1.25 mm \pm 0.05 mm \; maximum \; from the pre-load position \\ \text{Operates bi-directionally.} \end{array}$ 



VIEW: B-B



Value through Innovation 10721 Walker Street Cypress, California 90630 (714) 761-6368 Fax: (714) 761-8880 Visit us at www.idtechproducts.com ISO 9001-2000 Certified

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